

## CoolMOS™ Power Transistor

### Features

- Intrinsic fast-recovery body diode
- Extremely low reverse recovery charge
- Ultra low gate charge
- Extreme  $dv/dt$  rated
- High peak current capability
- Qualified for industrial grade applications according to JEDEC<sup>1)</sup>

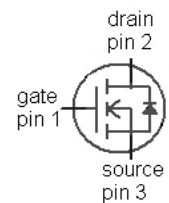
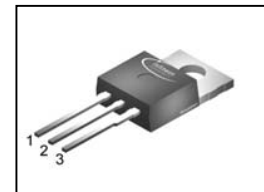
### CoolMOS CFD designed for:

- Soft switching PWM Stages
- LCD & CRT TV

### Product Summary

|                     |     |          |
|---------------------|-----|----------|
| $V_{DS} @ T_{Jmax}$ | 650 | V        |
| $R_{DS(on),max}$    | 0.7 | $\Omega$ |
| $I_D$               | 6.6 | A        |

PG-TO220



| Type        | Package  | Marking  |
|-------------|----------|----------|
| SPP07N60CFD | PG-TO220 | 07N60CFD |

**Maximum ratings**, at  $T_J=25^\circ\text{C}$ , unless otherwise specified

| Parameter                                      | Symbol            | Conditions                                                              | Value       | Unit             |
|------------------------------------------------|-------------------|-------------------------------------------------------------------------|-------------|------------------|
| Continuous drain current                       | $I_D$             | $T_C=25^\circ\text{C}$                                                  | 6.6         | A                |
|                                                |                   | $T_C=100^\circ\text{C}$                                                 | 4.3         |                  |
| Pulsed drain current <sup>2)</sup>             | $I_{D,pulse}$     | $T_C=25^\circ\text{C}$                                                  | 17          |                  |
| Avalanche energy, single pulse                 | $E_{AS}$          | $I_D=3.3\text{ A}$ , $V_{DD}=50\text{ V}$                               | 230         | mJ               |
| Avalanche energy, repetitive <sup>2),3)</sup>  | $E_{AR}$          | $I_D=6.6\text{ A}$ , $V_{DD}=50\text{ V}$                               | 0.5         |                  |
| Avalanche current, repetitive <sup>2),3)</sup> | $I_{AR}$          |                                                                         | 6.6         | A                |
| Drain source voltage slope                     | $dv/dt$           | $I_D=6.6\text{ A}$ , $V_{DS}=480\text{ V}$ ,<br>$T_J=125^\circ\text{C}$ | 80          | V/ns             |
| Reverse diode $dv/dt$                          | $dv/dt$           | $I_S=6.6\text{ A}$ , $V_{DS}=480\text{ V}$ ,<br>$T_J=125^\circ\text{C}$ | 40          | V/ns             |
| Maximum diode commutation speed                | $di/dt$           |                                                                         | 600         | A/ $\mu\text{s}$ |
| Gate source voltage                            | $V_{GS}$          | static                                                                  | $\pm 20$    | V                |
|                                                |                   | AC ( $f > 1\text{ Hz}$ )                                                | $\pm 30$    |                  |
| Power dissipation                              | $P_{tot}$         | $T_C=25^\circ\text{C}$                                                  | 83          | W                |
| Operating and storage temperature              | $T_J$ , $T_{stg}$ |                                                                         | -55 ... 150 | $^\circ\text{C}$ |
| Mounting torque                                |                   | M3 & M3.5 screws                                                        | 60          | Ncm              |

| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

#### Thermal characteristics

|                                                             |            |                                       |   |   |     |     |
|-------------------------------------------------------------|------------|---------------------------------------|---|---|-----|-----|
| Thermal resistance, junction - case                         | $R_{thJC}$ |                                       | - | - | 1.5 | K/W |
| Thermal resistance, junction - ambient                      | $R_{thJA}$ | leaded                                | - | - | 62  |     |
| Soldering temperature, wave soldering only allowed at leads | $T_{sold}$ | 1.6 mm (0.063 in.) from case for 10 s | - | - | 260 | °C  |

#### Electrical characteristics, at $T_j=25\text{ °C}$ , unless otherwise specified

#### Static characteristics

|                                  |               |                                                                   |     |      |     |               |
|----------------------------------|---------------|-------------------------------------------------------------------|-----|------|-----|---------------|
| Drain-source breakdown voltage   | $V_{(BR)DSS}$ | $V_{GS}=0\text{ V}$ , $I_D=250\text{ }\mu\text{A}$                | 600 | -    | -   | V             |
| Avalanche breakdown voltage      | $V_{(BR)DS}$  | $V_{GS}=0\text{ V}$ , $I_D=6.6\text{ A}$                          | -   | 700  | -   |               |
| Gate threshold voltage           | $V_{GS(th)}$  | $V_{DS}=V_{GS}$ , $I_D=300\text{ }\mu\text{A}$                    | 3   | 4    | 5   |               |
| Zero gate voltage drain current  | $I_{DSS}$     | $V_{DS}=600\text{ V}$ , $V_{GS}=0\text{ V}$ , $T_j=25\text{ °C}$  | -   | 0.6  | -   | $\mu\text{A}$ |
|                                  |               | $V_{DS}=600\text{ V}$ , $V_{GS}=0\text{ V}$ , $T_j=150\text{ °C}$ | -   | 630  | -   |               |
| Gate-source leakage current      | $I_{GSS}$     | $V_{GS}=20\text{ V}$ , $V_{DS}=0\text{ V}$                        | -   | -    | 100 | nA            |
| Drain-source on-state resistance | $R_{DS(on)}$  | $V_{GS}=10\text{ V}$ , $I_D=4.6\text{ A}$ , $T_j=25\text{ °C}$    | -   | 0.59 | 0.7 | $\Omega$      |
|                                  |               | $V_{GS}=10\text{ V}$ , $I_D=4.6\text{ A}$ , $T_j=150\text{ °C}$   | -   | 1.6  | -   |               |
| Gate resistance                  | $R_G$         | $f=1\text{ MHz}$ , open drain                                     | -   | 1.2  | -   |               |
| Transconductance                 | $g_{fs}$      | $ V_{DS} >2 I_D R_{DS(on)max}$ , $I_D=4.6\text{ A}$               | -   | 5.0  | -   | S             |

| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

**Dynamic characteristics**

|                                                            |              |                                                                                        |   |     |   |    |
|------------------------------------------------------------|--------------|----------------------------------------------------------------------------------------|---|-----|---|----|
| Input capacitance                                          | $C_{iss}$    | $V_{GS}=0\text{ V}, V_{DS}=25\text{ V},$<br>$f=1\text{ MHz}$                           | - | 790 | - | pF |
| Output capacitance                                         | $C_{oss}$    |                                                                                        | - | 260 | - |    |
| Reverse transfer capacitance                               | $C_{rss}$    |                                                                                        | - | 16  | - |    |
| Effective output capacitance, energy related <sup>4)</sup> | $C_{o(er)}$  | $V_{GS}=0\text{ V}, V_{DS}=0\text{ V}$<br>to 480 V                                     | - | 30  | - |    |
| Effective output capacitance, time related <sup>5)</sup>   | $C_{o(tr)}$  |                                                                                        | - | 55  | - |    |
| Turn-on delay time                                         | $t_{d(on)}$  | $V_{DD}=400\text{ V},$<br>$V_{GS}=10\text{ V}, I_D=6.6\text{ A},$<br>$R_G=6.8\ \Omega$ | - | 12  | - | ns |
| Rise time                                                  | $t_r$        |                                                                                        | - | 25  | - |    |
| Turn-off delay time                                        | $t_{d(off)}$ |                                                                                        | - | 36  | - |    |
| Fall time                                                  | $t_f$        |                                                                                        | - | 9   | - |    |

**Gate Charge Characteristics**

|                       |               |                                                                              |   |     |    |    |
|-----------------------|---------------|------------------------------------------------------------------------------|---|-----|----|----|
| Gate to source charge | $Q_{gs}$      | $V_{DD}=480\text{ V}, I_D=6.6\text{ A},$<br>$V_{GS}=0\text{ to }10\text{ V}$ | - | 6.6 | -  | nC |
| Gate to drain charge  | $Q_{gd}$      |                                                                              | - | 20  | -  |    |
| Gate charge total     | $Q_g$         |                                                                              | - | 35  | 47 |    |
| Gate plateau voltage  | $V_{plateau}$ |                                                                              | - | 7.2 | -  | V  |

<sup>1)</sup> J-STD20 and JESD22

<sup>2)</sup> Pulse width  $t_p$  limited by  $T_{j,max}$

<sup>3)</sup> Repetitive avalanche causes additional power losses that can be calculated as  $P_{AV}=E_{AR}*f$ .

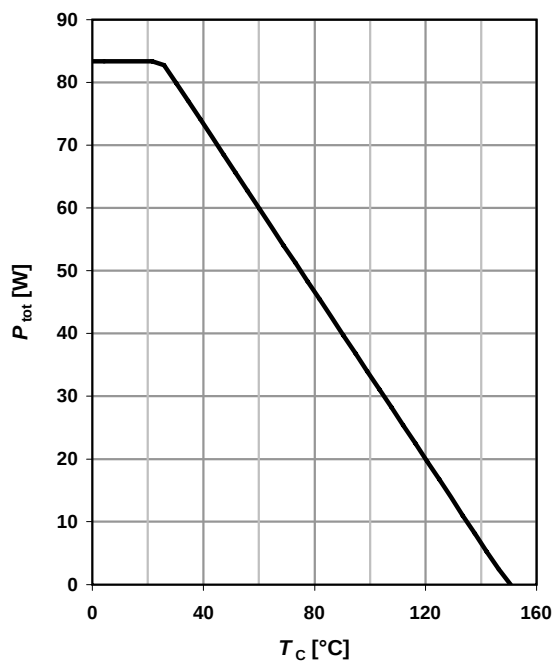
<sup>4)</sup>  $C_{o(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

<sup>5)</sup>  $C_{o(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

| Parameter                                     | Symbol        | Conditions                                                         | Values |      |      | Unit             |
|-----------------------------------------------|---------------|--------------------------------------------------------------------|--------|------|------|------------------|
|                                               |               |                                                                    | min.   | typ. | max. |                  |
| Reverse Diode                                 |               |                                                                    |        |      |      |                  |
| Diode continuous forward current              | $I_S$         | $T_C=25\text{ }^{\circ}\text{C}$                                   | -      | -    | 6.6  | A                |
| Diode pulse current <sup>2)</sup>             | $I_{S,pulse}$ |                                                                    | -      | -    | 17   |                  |
| Diode forward voltage                         | $V_{SD}$      | $V_{GS}=0\text{ V}, I_F=I_S,$<br>$T_J=25\text{ }^{\circ}\text{C}$  | -      | 1.0  | 1.2  | V                |
| Reverse recovery time                         | $t_{rr}$      | $V_R=480\text{ V}, I_F=I_S,$<br>$di_F/dt=100\text{ A}/\mu\text{s}$ | -      | 104  | 200  | ns               |
| Reverse recovery charge                       | $Q_{rr}$      |                                                                    | -      | 0.5  | 1.42 | $\mu\text{C}$    |
| Peak reverse recovery current                 | $I_{rrm}$     |                                                                    | -      | 8    | -    | A                |
| Peak rate of fall of reverse recovery current | $di_{rr}/dt$  | $T_J=25\text{ }^{\circ}\text{C}$                                   | -      | 1000 | -    | A/ $\mu\text{s}$ |

## 1 Power dissipation

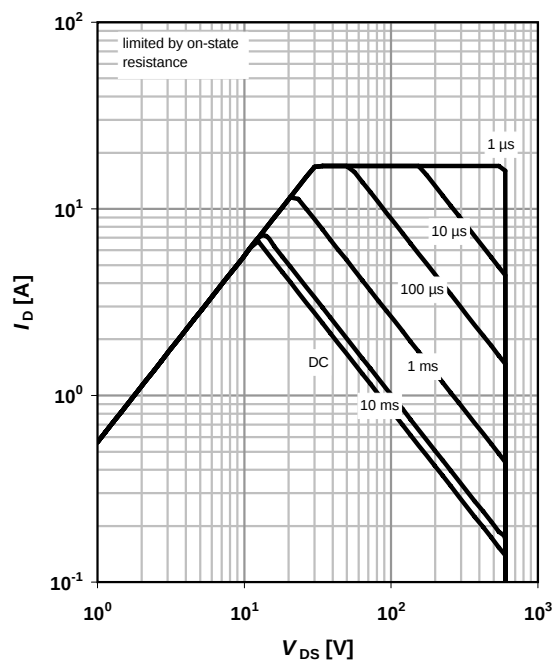
$$P_{\text{tot}} = f(T_C)$$



## 2 Safe operating area

$$I_D = f(V_{DS}); T_C = 25^\circ\text{C}; D = 0$$

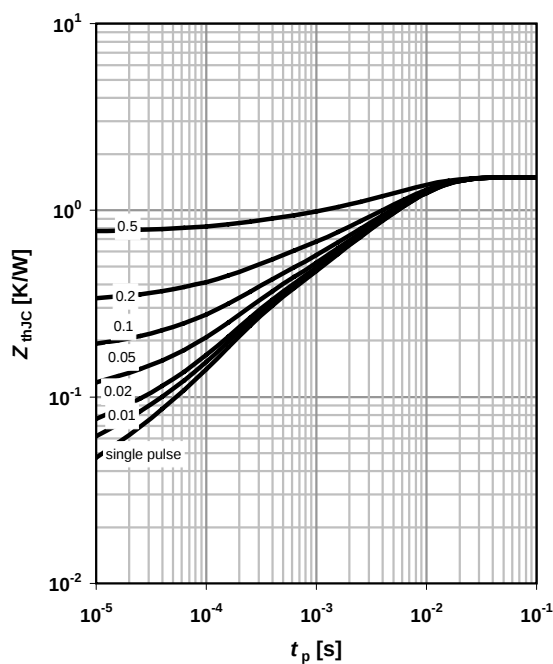
parameter:  $t_p$



## 3 Max. transient thermal impedance

$$I_D = f(V_{DS}); T_J = 25^\circ\text{C}$$

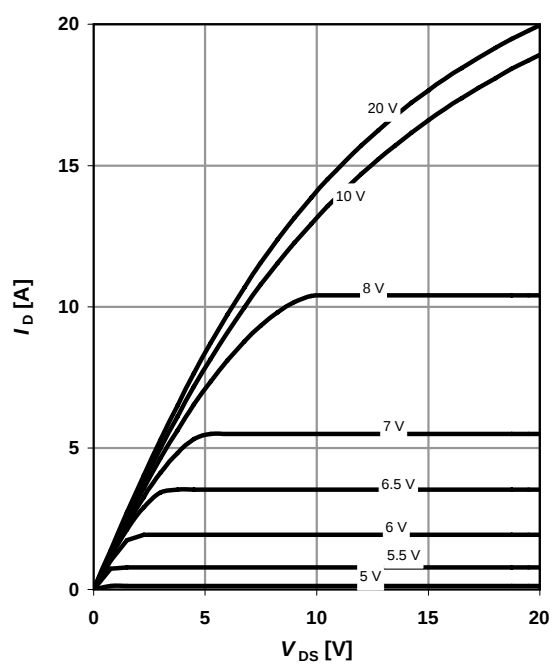
parameter:  $D = t_p / T$



## 4 Typ. output characteristics

$$I_D = f(V_{DS}); T_J = 25^\circ\text{C}$$

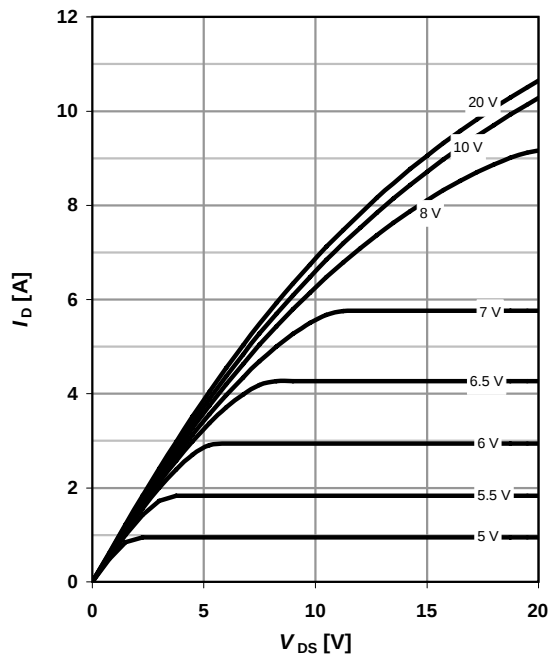
parameter:  $V_{GS}$



### 5 Typ. output characteristics

$$I_D = f(V_{DS}); T_j = 150^\circ\text{C}$$

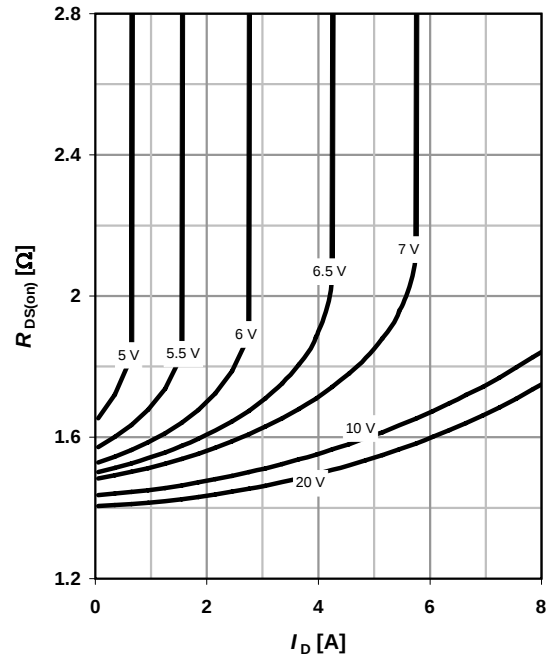
parameter:  $V_{GS}$



### 6 Typ. drain-source on-state resistance

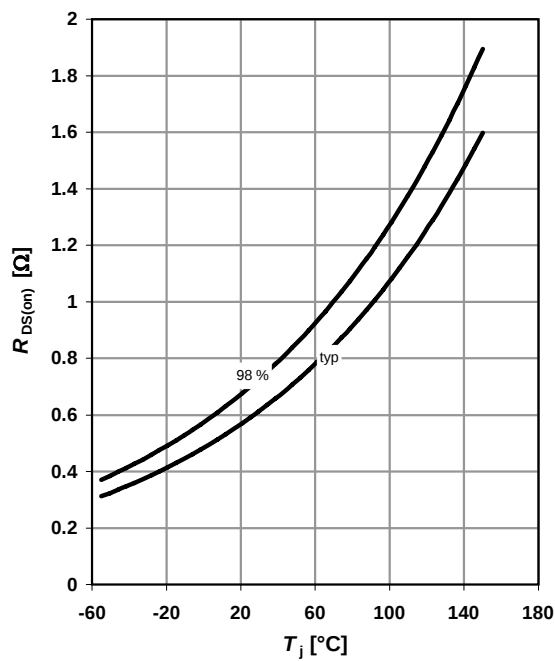
$$R_{DS(on)} = f(I_D); T_j = 150^\circ\text{C}$$

parameter:  $V_{GS}$



### 7 Drain-source on-state resistance

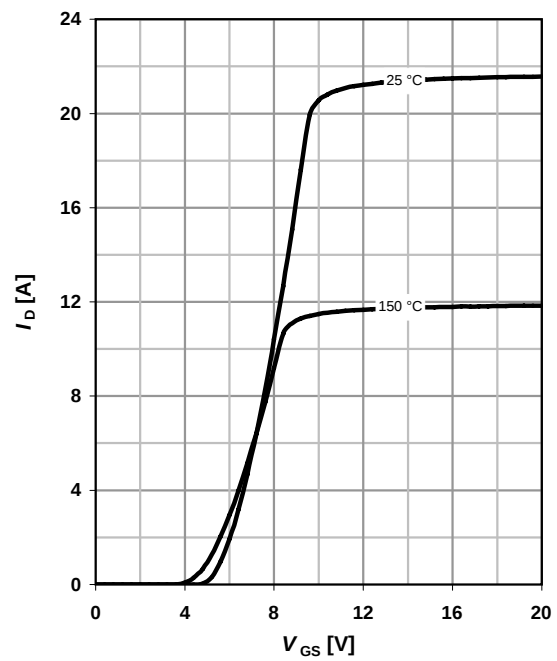
$$R_{DS(on)} = f(T_j); I_D = 4.6\text{ A}; V_{GS} = 10\text{ V}$$



### 8 Typ. transfer characteristics

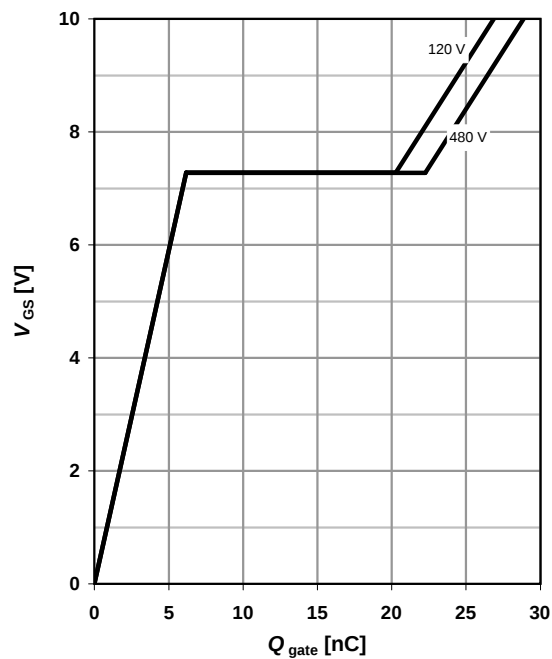
$$I_D = f(V_{GS}); |V_{DS}| > 2|I_D|R_{DS(on)\text{max}}$$

parameter:  $T_j$



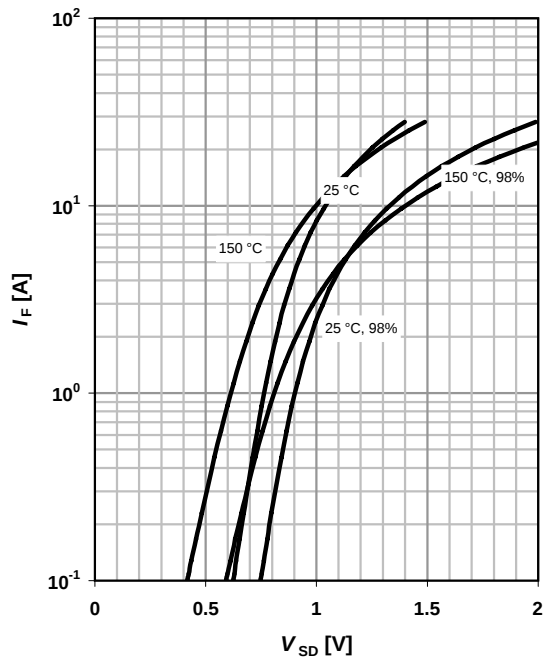
### 9 Typ. gate charge

 $V_{GS}=f(Q_{gate}); I_D=6.6 \text{ A pulsed}$ 

parameter:  $V_{DD}$ 


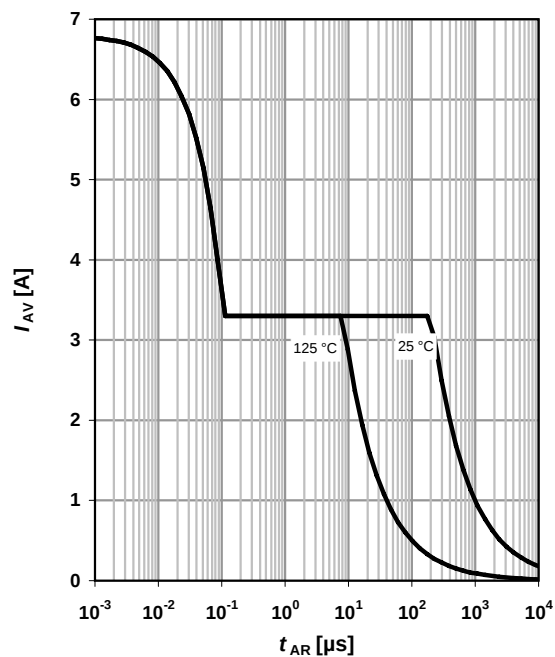
### 10 Forward characteristics of reverse diode

 $I_F=f(V_{SD})$ 

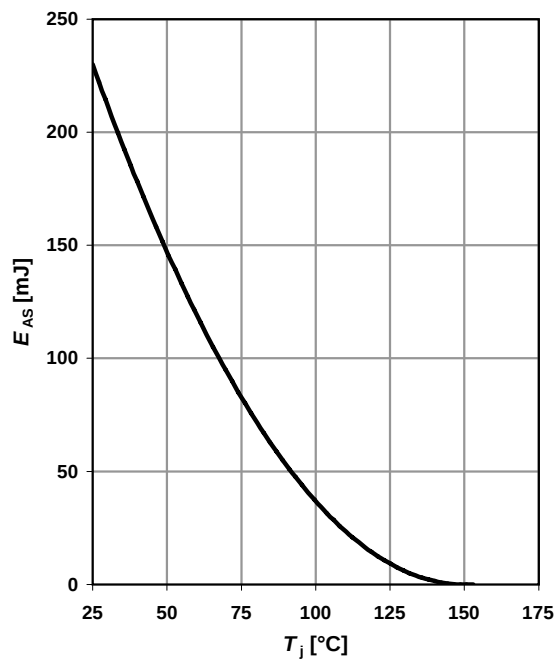
parameter:  $T_j$ 


### 11 Avalanche SOA

 $I_{AR}=f(t_{AR})$ 

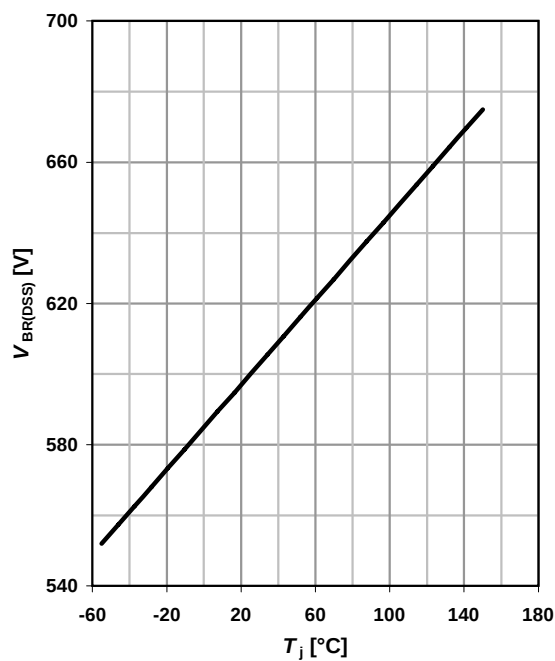
parameter:  $T_{j(start)}$ 


### 12 Avalanche energy

 $E_{AS}=f(T_j); I_D=3.3 \text{ A}; V_{DD}=50 \text{ V}$ 


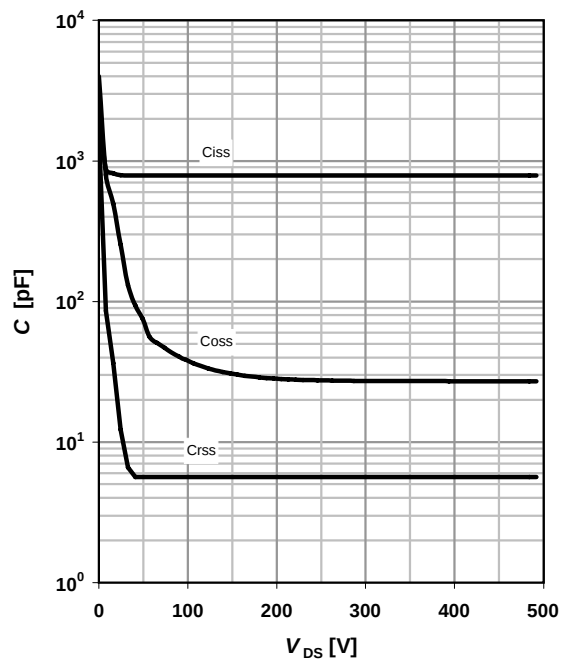
### 13 Drain-source breakdown voltage

$$V_{BR(DSS)} = f(T_j);$$



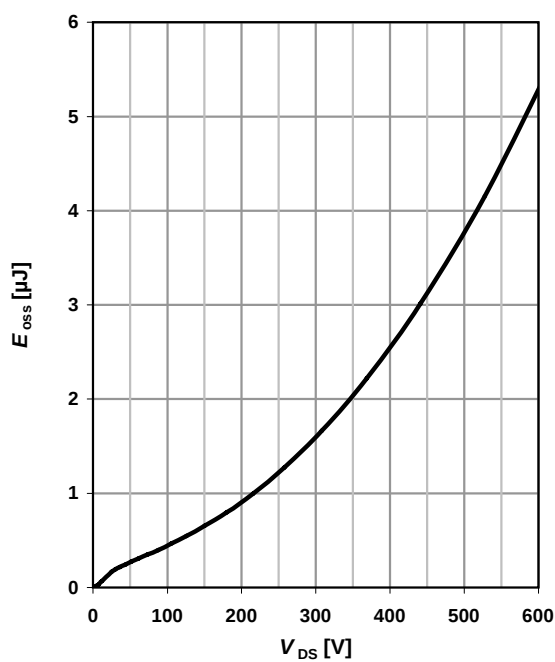
### 14 Typ. capacitances

$$C = f(V_{DS}); V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$$



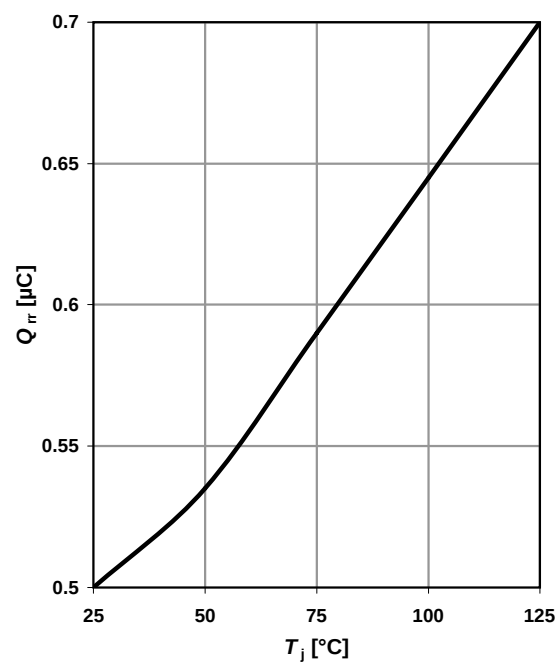
### 15 Typ. $C_{oss}$ stored energy

$$E_{oss} = f(V_{DS})$$



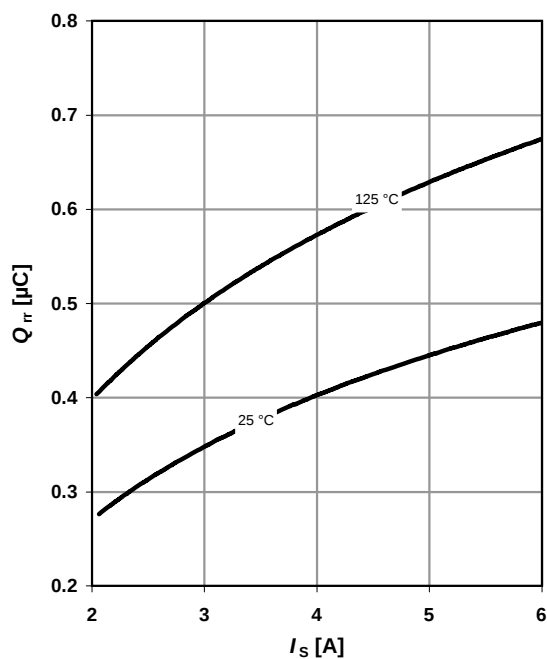
### 16 Typ. reverse recovery charge

$$Q_{rr} = f(T_j); \text{parameter: } I_D = 6.6 \text{ A}$$



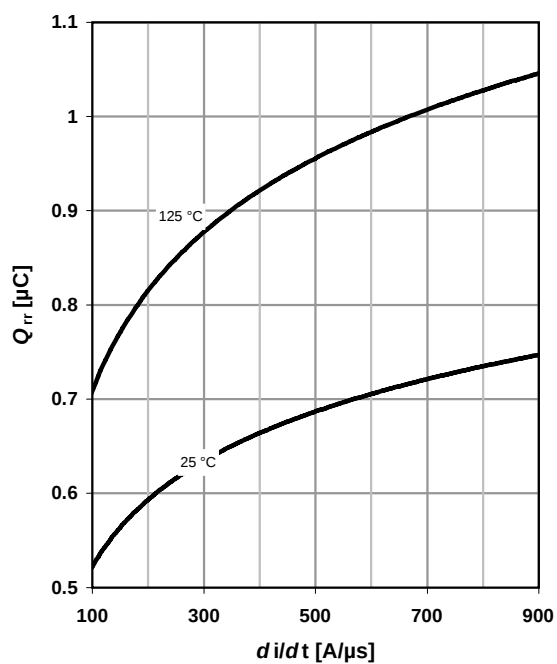
### 17 Typ. reverse recovery charge

$Q_{rr}=f(I_S)$ ; parameter:  $di/dt=100\text{ A}/\mu\text{s}$

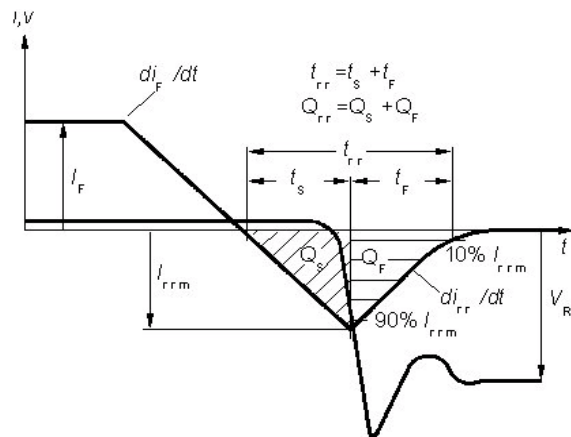


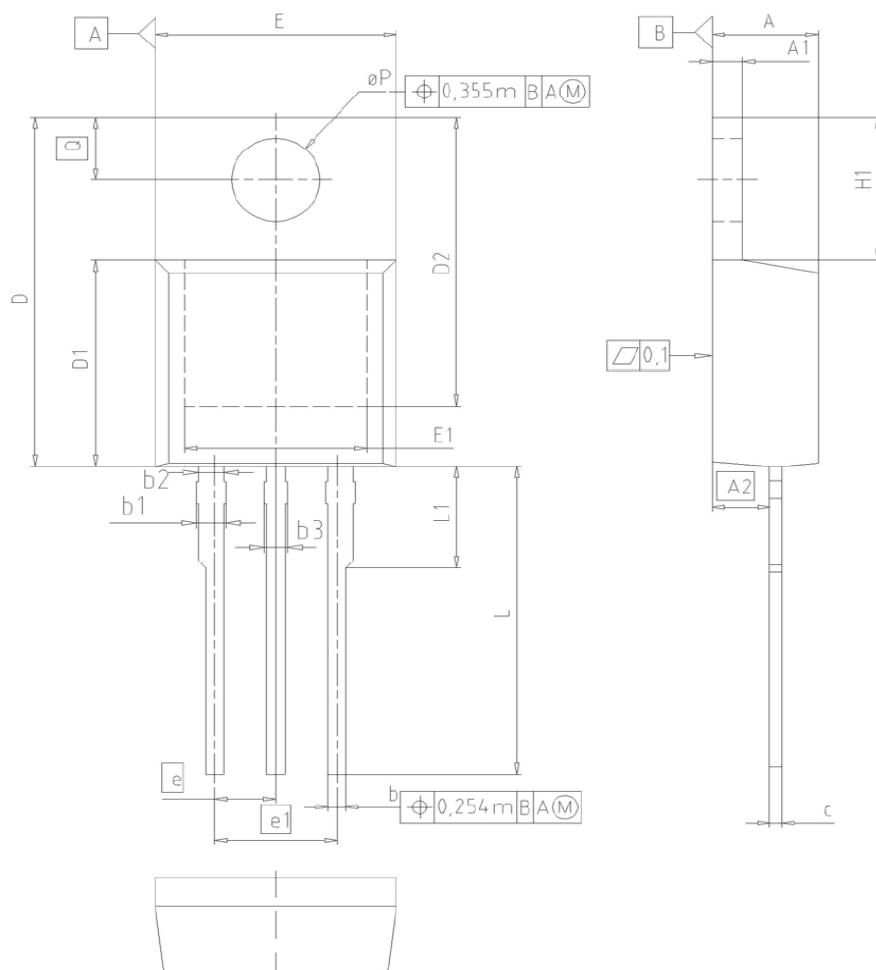
### 18 Typ. reverse recovery charge

$Q_{rr}=f(di/dt)$ ; parameter:  $I_D=6.6\text{ A}$



# Definition of diode switching characteristics





| DIM      | MILLIMETERS |       | INCHES |       |
|----------|-------------|-------|--------|-------|
|          | MIN         | MAX   | MIN    | MAX   |
| A        | 4.30        | 4.57  | 0.169  | 0.180 |
| A1       | 1.17        | 1.40  | 0.046  | 0.055 |
| A2       | 2.15        | 2.72  | 0.085  | 0.107 |
| b        | 0.65        | 0.86  | 0.026  | 0.034 |
| b1       | 0.95        | 1.40  | 0.037  | 0.055 |
| b2       | 0.95        | 1.15  | 0.037  | 0.045 |
| b3       | 0.65        | 1.15  | 0.026  | 0.045 |
| c        | 0.33        | 0.60  | 0.013  | 0.024 |
| D        | 14.81       | 15.95 | 0.583  | 0.628 |
| D1       | 8.51        | 9.45  | 0.335  | 0.372 |
| D2       | 12.19       | 13.10 | 0.480  | 0.516 |
| E        | 9.70        | 10.36 | 0.382  | 0.408 |
| E1       | 6.50        | 8.60  | 0.256  | 0.339 |
| e        | 2.54        |       | 0.100  |       |
| e1       | 5.08        |       | 0.200  |       |
| N        | 3           |       | 3      |       |
| H1       | 5.90        | 6.90  | 0.232  | 0.272 |
| L        | 13.00       | 14.00 | 0.512  | 0.551 |
| L1       | -           | 4.80  | -      | 0.189 |
| $\phi P$ | 3.60        | 3.89  | 0.142  | 0.153 |
| Q        | 2.60        | 3.00  | 0.102  | 0.118 |

|                                                                                                                     |
|---------------------------------------------------------------------------------------------------------------------|
| <b>DOCUMENT NO.</b><br>Z8B00003318                                                                                  |
| <b>SCALE</b><br>0<br>2.5<br>5mm                                                                                     |
| <b>EUROPEAN PROJECTION</b><br> |
| <b>ISSUE DATE</b><br>23-08-2007                                                                                     |
| <b>REVISION</b><br>05                                                                                               |

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